

2.1x0.7mm RIGHT ANGLE SMD CHIP LED **LAMP**

Part Number: APJA2107SURCK Hyper Red

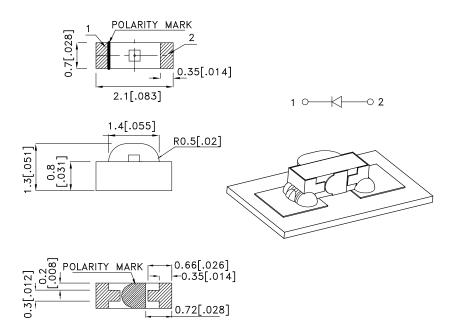
Features

- 2.1x0.7mm right angle SMT LED, 1.3mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.15(0.006") unless otherwise noted.
- 3. Specifications are subject to change without notice.4. The device has a single mounting surface. The device must be mounted according to the specifications.





SPEC NO: DSAD1026 **REV NO: V.9 DATE: SEP/23/2009** PAGE: 1 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** ERP: 1203001552 DRAWN: Y.L.Zhong

Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APJA2107SURCK	Hyper Red (AlGaInP)	WATER CLEAR	110	250	120°

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	650		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red	630		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	28		nm	IF=20mA
С	Capacitance	Hyper Red	35		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red	1.95	2.5	V	IF=20mA
lr	Reverse Current	Hyper Red		10	uA	VR=5V

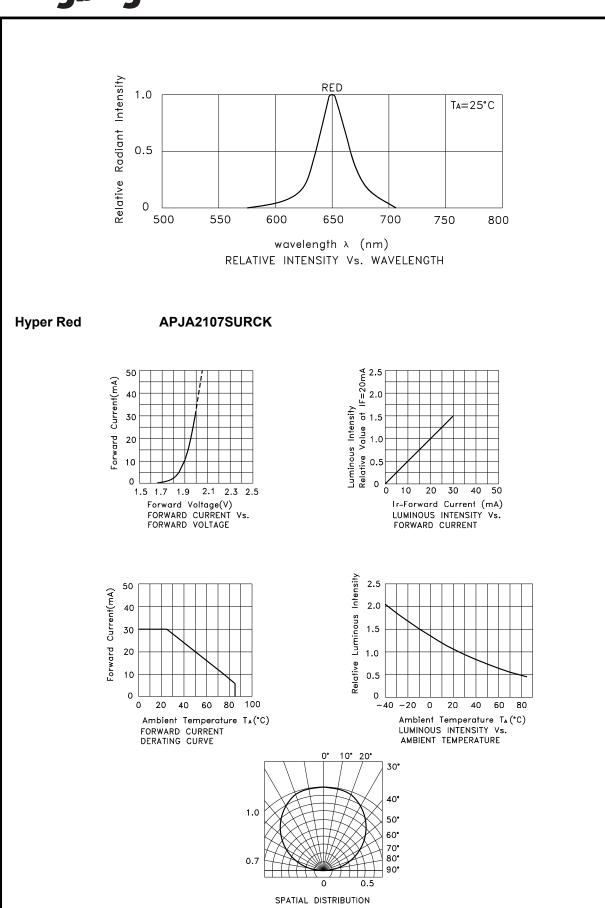
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red	Units	
Power dissipation	75	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	185	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

SPEC NO: DSAD1026 **REV NO: V.9** DATE: SEP/23/2009 PAGE: 2 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Y.L.Zhong ERP: 1203001552



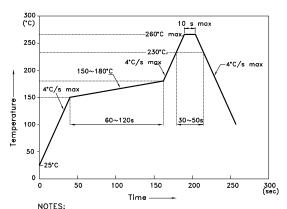
 SPEC NO: DSAD1026
 REV NO: V.9
 DATE: SEP/23/2009
 PAGE: 3 OF 5

 APPROVED: WYNEC
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 ERP: 1203001552

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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



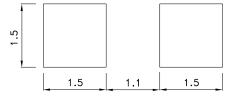
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

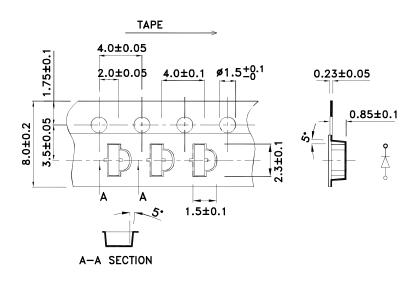
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature. to high temperature.

 3.Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



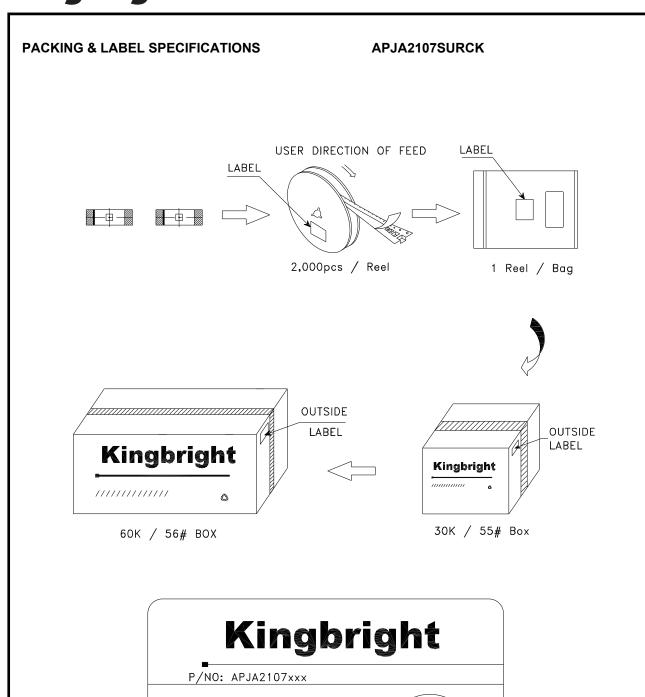
Tape Dimensions (Units : mm)

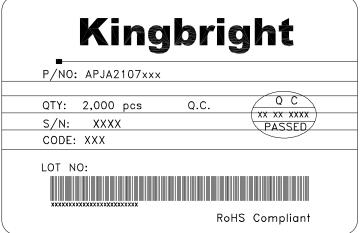


PAGE: 4 OF 5

ERP: 1203001552

SPEC NO: DSAD1026 **REV NO: V.9** DATE: SEP/23/2009 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Y.L.Zhong





SPEC NO: DSAD1026 APPROVED: WYNEC REV NO: V.9 CHECKED: Allen Liu DATE: SEP/23/2009 DRAWN: Y.L.Zhong PAGE: 5 OF 5 ERP: 1203001552

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